VISIBLE LIGHT PRODUCTS SPECIFICATION

HTLB4a-46WOR WOR WOR



Drawn by	Checked by	Approved by



REV:B

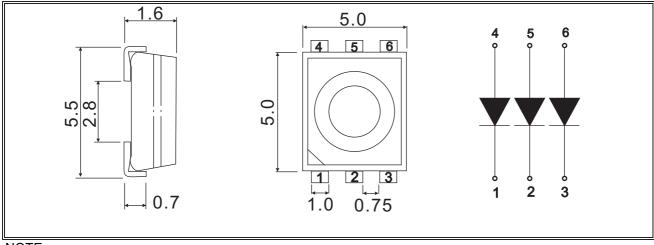


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DEVICES

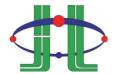
Part Number	Lens		Source		
Part Number	Color	Diffusion	Dice Source	Color	
HTLB4a-46WOR WOR WOR	Water clear	Non-Diffused	AllnGaP/GaP	Super Fresh Red	

PACKAGE DIMENSIONS



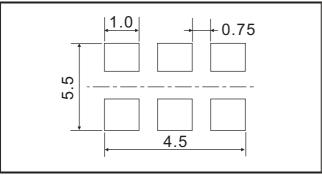
NOTE:

- 1.All dimensions are in millimeter.
- 2.specifications are subject to change without notice.
- 3. Tolerance is ±0.3mm unless otherwise noted.



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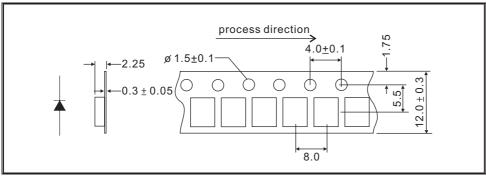
■RECOMMENDED SOLDERING PATTERN



NOTE:

- 1.All dimensions are in millimeter.
- 2.specifications are subject to change without notice.

TAPE SPECTIFICATIONS



NOTE:

- 1.All dimensions are in millimeter.
- 2.specifications are subject to change without notice.



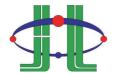
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BABSOLUTE MAXIMUM RATINGS

TA=25°C

PARAMETER	SYMBOL	MAX. RATING	UNIT	
Power Dissipation	Pd	180	mW	
Continuous Forward Current	IF	75	mA	
Peak Forward Current *1	IFM	150	mA	
Reverse Voltage	VR	5	V	
LED Junction Temperature	Tj	100	°C	
Operating Temperature	Topr	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	°C	
Reflow Soldering (preheat 150-180°ℂ 60-120sec, soldering temp 260°ℂ 5sec)				

^{*1.}Duty Ratio=0.1%, Pulse Width=10us.



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^{*2.}Iron soldering in 350°C within 5 seconds will not cause damage to the dice. But be aware of the high temperature will not only make the epoxy soften but also cause the lead moving and the gold wire broken and even open. So before returning to the normal temperature PLEASE AVOID any serious pressure on the top of epoxy and lead.

BELECTRIC-OPTICAL CHARACTERISTICS

TA=25°C

PARAMETER	SYMBOL	TEST CONDITION	MIN	ТҮР	MAX	UNIT
View Angle of Half Power	201/2	IF=60mA		120		deg
Forward Voltage	VF	IF-00IIIA		2.1	2.4	V
Reverse Current	IR	VR=5V			10	μ A
Luminous Intensity *2	IV		700	1300		mcd
Peak Emission Wavelength	λρ			635		nm
Dominate Wave Length *3	λ d(HUE)	IF=60mA		625		nm
Spectrum Width Of Half Valve	Δλ			25		nm

^{*2.}Tolerance:±15% HUEY-JANN measuring equipment: EXELTRON 2001. 2.S370 made by U.D.T.



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^{*3.} The dominate wavelength , λ d, is derived from the CIE Chromaticity Diagram and represents the color of the device.

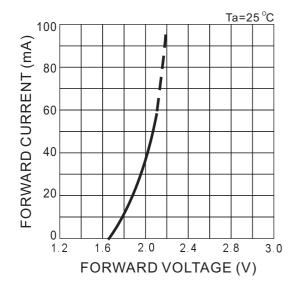
RELIABILITY TEST

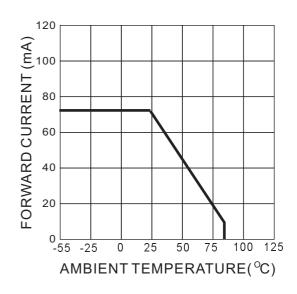
Classification	Test Item	Test Conditions	Refer to Temperature-profile
Reflow	Lead Solder	Pre-heat=120~150°C Pre-heat time=120sec Max Peak temperature=240°C Max Soldering time=10sec Max	2.5 ~ 5°C/Sec
	Lead free Solder	Pre-heat=180~200°C Pre-heat time=120sec Max Peak temperature=260°C Max Soldering time=10sec Max	260°C Max 10Sec Max 10Sec Max 180 ~ 200°C Ave 220°C
Hand Soldering	•	=350℃ Max ne=3sec Max(one time only)	

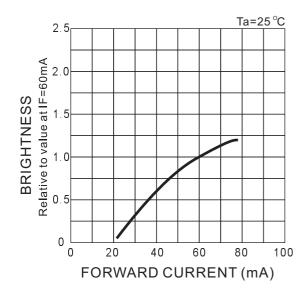


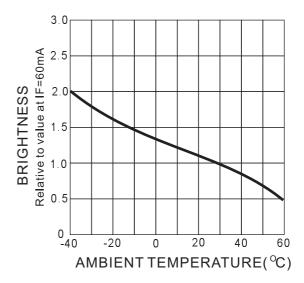
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TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES





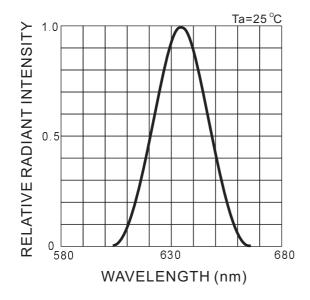


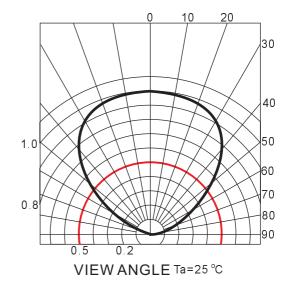




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TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES







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LED VF Bin Selection

IF=60mA

BIN CODE	Forward Voltage		
BIN CODE	Minimum	Maximum	
d	1.8	2.0	
е	2.0	2.2	
f	2.2	2.4	

Voltage tolerance for each bin limit is $\pm 0.03V$

Brightness Bin Selection

I_F=60mA

BIN CODE	Brightness in mcd		
DIN CODE	Minimum	Maximum	
Р	880	1150	
Q	1150	1500	
R	1500	1900	
S	1900	2500	

Brightness tolerance for each bin limit is $\pm 15\%$



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